Status (patented, pending abandoned)

COMPLED DECLARATION AND POWER OF

As a below named inventor, I hereby declare that

Application No.

My residence, post office address and citizenship are as stated below next to my name.

(if plura invention	al names are listed belowed in the control of the c	 v) of the subject matter whi 	ch is claimed and for which a	patent is sought on the
Pro	duction Thereof			
believe am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: Group TII Nitride Semiconductor Substrate and Process for Production Thereof. he specification of which: (check one)				
		REGULAR OR DESIG	N APPLICATION	
	is attached hereto.			
	was filed on	a:	s application Serial No.	
	and was amended on	(if	applicable).	
	PC	T FILED APPLICATION ENT	ERING NATIONAL STAGE	
was described and claimed in International application No. PCT/JP03/08360				
	filed on <u>July 1,</u> any).	2003 a	nd as amended on <u>Novemb</u>	per 27, 2003 (if
I hereb claims,	y state that I have revie as amended by any ame	wed and understand the connament referred to above.	tents of the above-identified s	pecification, including the
l ackno Regula	owledge the duty to disclostions, §1.56.			Title 37, Code of Federal
listed b	elow and have also identi	nefits under 35 USC 119 of ar fied below any foreign applica	ny foreign application(s) for pate	ent or inventor's certificate ificate having a filing date
٠			PPLICATION(S)	•
	Country	Application	Date of Filing	Priority
			(day, month, year)	Claimed
	Japan	2002-193733	02, July, 2002	Yes
l hereb applica	y claim the benefit under tion(s) listed below:	I Title 35, United States Code §	119(e) of any United States pro	l ovisional patent
Applica	tion No.	Filing Date	Status (patented,	pending abandoned)
(Compl	lete this part only if this is	a continuing application.)		
subject manner materia	matter of each of the cl r provided by the first pa Il to patentability as define	aims of this application is no aragraph of 35 USC 112, I ed in Title 37 Code of Federal	d States application(s) listed but disclosed in the prior United acknowledge the duty to disclargulations §1.56 which becaunational filing date of this applic	States application in the lose information which is me available between the

Filing Date

Docket No.	

POWER OF ATTORNEY

The undersigned hereby authorizes the U.S. attorney or agent named herein to access as to any action to be taken in the	ept and follow	instructions from
regarding this application without direct communication between the U.S. attorney or a the event of a change in the persons from whom instructions may be taken, the U.S. attorney or a change in the persons from whom instructions may be taken, the U.S. attorney or a change in the persons from whom instructions may be taken, the U.S. attorney or a change in the persons from whom instructions may be taken, the U.S. attorney or a change in the persons from whom instructions may be taken.	agent áðnd the	undersigned. Ir
will be so notified by the undersigned.		

As a named inventor, I hereby appoint the registered patent attorneys represented by Customer No. 000466 to prosecute this application and transact all business in the Patent and Trademark Office connected therewith, including: Robert J. PATCH, Reg. No. 17,355, Andrew J. PATCH, Reg. No. 32,925, Robert F. HARGEST, Reg. No. 25,590, Benoît CASTEL, Reg. No. 35,041, Thomas W. PERKINS, Reg. No. 33,027, Roland E. LONG, Jr., Reg. No. 41,949, Eric JENSEN, Reg. No. 37,855, Liam MCDOWELL, Reg. No. 44,231 and Philip A. DUBOIS, Reg. No. 50,696,

c/o YOUNG & THOMPSON Second Floor 745 South 23rd Street Arlington, Virginia 22202 **Customer Number**

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Address all telephone calls to Young & Thompson at 703/521-2297. Telefax: 703/685-0573.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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